October 2019

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#### 4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

### **Features**

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI<sup>TM</sup>, HDMI<sup>TM</sup>, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

- This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability.
- https://www.diodes.com/quality/product-definitions/

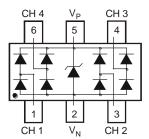
## **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208<sup>(3)</sup>
- Weight: 0.006 grams (Approximate)





Top View



Device Schematic

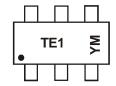
## **Ordering Information (Note 4)**

Part Number	Case	Packaging
D1213A-04S-7	SOT363	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



TE1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	? :	2013	2014	201	5	2016	2017	20	18	2019
Code	Υ	Z		Α	В	С		D	E	F	-	G
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Operating Supply Voltage	V <sub>P</sub> - V <sub>N</sub>	6.0	V	_
DC Voltage at Any Channel Input	_	$(V_N - 0.5)$ to $(V_P + 0.5)$	V	_
Peak Pulse Current	IPP	5.0	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_CONTACT</sub>	±8	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD\_AIR}$	±15	kV	IEC 61000-4-2 Standard

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

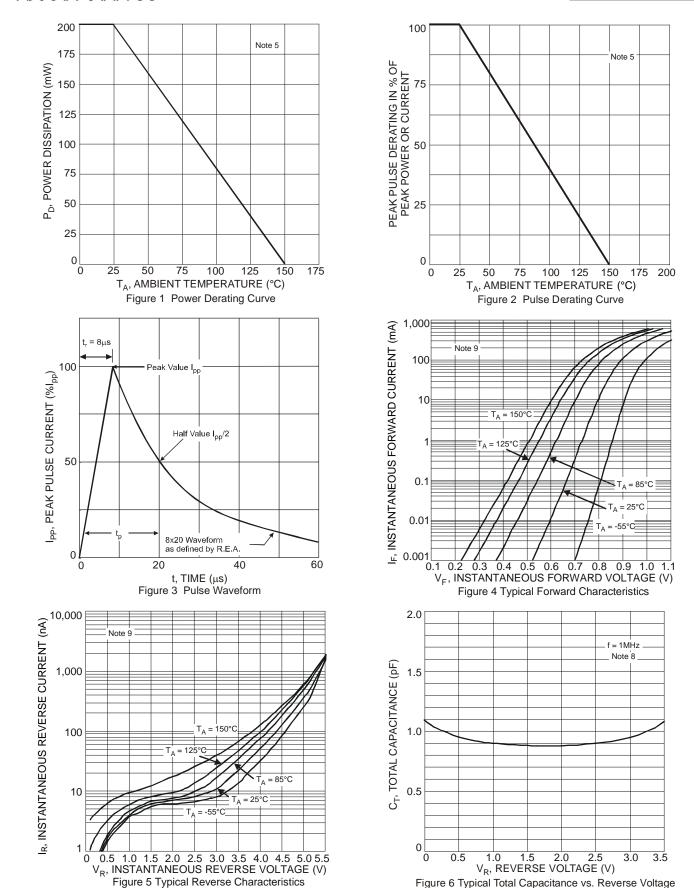
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Operating Supply Voltage	V <sub>P</sub>	_	3.3	5.5	V	_
Operating Supply Current (Note 6)	lР	_	_	8.0	μΑ	$(V_P - V_N) = 3.3V$
Channel Leakage Current (Note 6)	I <sub>R</sub>	_	0.1	1.0	μΑ	$V_P = 5V$ , $V_N = 0V$
Reverse Breakdown Voltage	$V_{BR}$	6.0	_	_	V	$I_R = 1mA$
Clamping Voltage, Positive Transients	V <sub>CL1</sub>	_	10.0	_	V	I <sub>PP</sub> = 1A (Note 7)
Clamping Voltage, Negative Transients	V <sub>CL2</sub>	_	-1.7	_	V	I <sub>PP</sub> = -1A (Note 7)
Forward Voltage for Top Diode	$V_{FD1}$	0.60	0.80	0.95	V	I <sub>F</sub> = 8mA, any channel to V <sub>P</sub>
Forward Voltage for Bottom Diode	$V_{FD2}$	0.60	0.80	0.95	V	I <sub>F</sub> = 8mA, V <sub>N</sub> to any channel
Dynamic Resistance	R <sub>DYN</sub>	_	0.9	_	Ω	I <sub>PP</sub> = 1A (Note 7)
Channel Input Capacitance	Ст	ı	0.85	1.2	pF	$V_{IN} = 1.65V, V_P = 3.3V,$ $V_N = 0V, f = 1MHz$

#### Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Clamping voltage value is based on an  $8x20\mu s$  peak pulse current (Ipp) waveform. 8. Measured from any channel to Vn.

- Measured from VP to VN.
  For information on the impact of Diodes Incorporated's USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote\_dnote.html.



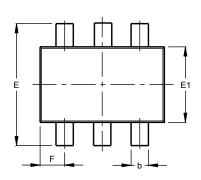


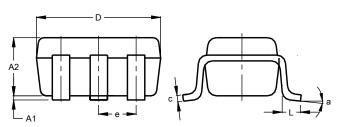


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



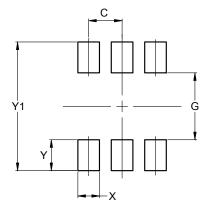


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
U	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



Dimensions	Value		
Dillielisions	(in mm)		
С	0.650		
G	1.300		
Х	0.420		
Y	0.600		
Y1	2.500		



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